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Thank you for your cooperation and understanding,

WeEn Semiconductors





Dual power Schottky diode Rev. 2 — 24 May 2012

Product data sheet

Product profile 1.

1.1 General description

Dual common cathode power Schottky diode designed for high frequency switched mode power supplies in a SOT78 (TO-220AB) plastic package.

1.2 Features and benefits

- High junction temperature capability
- Low leakage current

- Negligible switching losses
- Optimised design to give low V_F and high T_{j(max)}

1.3 Applications

- DC to DC converters
- Freewheeling diode

- OR-ing diode
- Switched mode power supply rectifier

1.4 Quick reference data

Table 1. **Quick reference data**

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	-	110	V
I _{F(AV)}	average forward current	square-wave pulse; δ = 0.5 ; T _j ≤ 163 °C; per diode; see <u>Figure 1</u> ; see <u>Figure 2</u> ; see <u>Figure 3</u>	-	-	10	A
I _{O(AV)}	average output current	square-wave pulse; $\delta = 0.5$; T _{mb} ≤ 161 °C; both diodes conducting	-	-	20	А
Tj	junction temperature		-	-	175	°C
Static cha	acteristics					
V _F	forward voltage	I _F = 10 A; T _j = 25 °C; see <u>Figure 6</u>	-	-	0.77	V
		$I_F = 10 \text{ A}; T_j = 125 \text{ °C}; \text{ see } \frac{\text{Figure 6}}{1000 \text{ C}}$	-	0.59	0.64	V
I _R	reverse current	V_R = 110 V; T_j = 25 °C; see <u>Figure 7</u>	-	2.5	6	μA
		V_R = 110 V; T_j = 125 °C; see <u>Figure 7</u>	-	1.5	6.5	mA



2. Pinning information

Table 2.	Pinning	information		
Pin	Symbol	Description	Simplified outline	Graphic symbol
1	A1	anode 1		
2	К	cathode	mb	
3	A2	anode 2		к
mb	к	mounting base; cathode		sym125

SOT78 (TO-220AB)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
NXPS20H110C	TO-220AB	plastic single-ended package; heatsink mounted; 1 mounting hole; 3-lead TO-220AB	SOT78

4. Limiting values

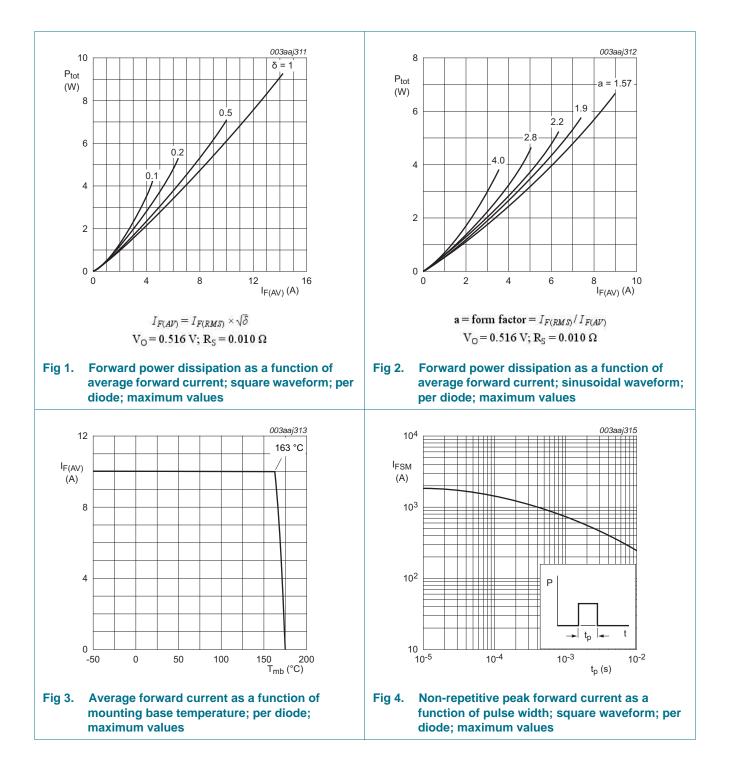
Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{RRM}	repetitive peak reverse voltage		-	110	V
I _{F(AV)}	average forward current	square-wave pulse; $\delta = 0.5$; $T_j \le 163 \text{ °C}$; per diode; see <u>Figure 1</u> ; see <u>Figure 2</u> ; see <u>Figure 3</u>	-	10	A
I _{O(AV)}	average output current	square-wave pulse; $\delta = 0.5$; $T_{mb} \le 161 \text{ °C}$; both diodes conducting	-	20	А
I _{FSM}	non-repetitive peak forward current	sine-wave pulse; $t_p = 10 \text{ ms}$; $T_{j(init)} = 25 \text{ °C}$; see Figure 4	-	250	А
T _{stg}	storage temperature		-65	175	°C
Tj	junction temperature		-	175	°C

NXPS20H110C Product data sheet

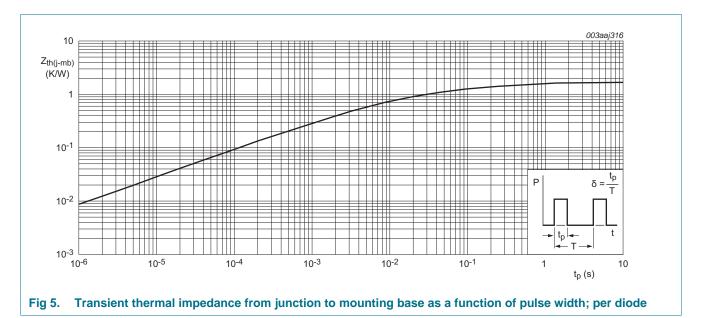
Dual power Schottky diode



Dual power Schottky diode

5. Thermal characteristics

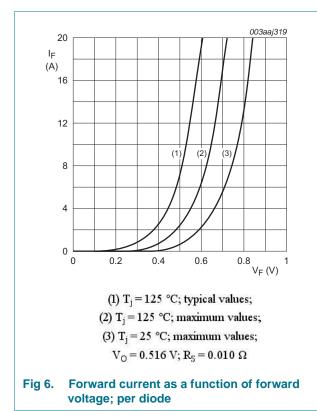
Table 5.	Thermal characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	with heatsink compound; per diode; see Figure 5	-	-	1.6	K/W
		with heatsink compound; both diodes conducting	-	-	0.9	K/W
R _{th(j-a)}	thermal resistance from junction to ambient	in free air	-	60	-	K/W

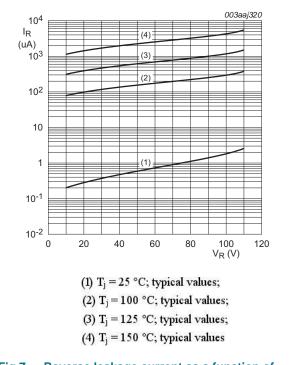


Dual power Schottky diode

6. Characteristics

Table 6.	Characteristics					
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	aracteristics					
V _F	forward voltage	I _F = 8 A; T _j = 25 °C; see <u>Figure 6</u>	-	-	0.71	V
		I _F = 10 A; T _j = 25 °C; see <u>Figure 6</u>	-	-	0.77	V
		$I_F = 16 \text{ A}; T_j = 25 \text{ °C}; \text{ see } Figure 6$	-	-	0.81	V
		$I_F = 20 \text{ A}; T_j = 25 \text{ °C}; \text{ see } Figure 6$	-	-	0.88	V
		$I_F = 8 \text{ A}; T_j = 125 \text{ °C}; \text{ see } Figure 6$	-	0.56	0.58	V
		I _F = 10 A; T _j = 125 °C; see <u>Figure 6</u>	-	0.59	0.64	V
		I _F = 16 A; T _j = 125 °C; see <u>Figure 6</u>	-	0.65	0.68	V
		I _F = 20 A; T _j = 125 °C; see <u>Figure 6</u>	-	0.67	0.73	V
I _R	reverse current	V _R = 110 V; T _j = 25 °C; see <u>Figure 7</u>	-	2.5	6	μA
		V _R = 110 V; T _j = 125 °C; see <u>Figure 7</u>	-	1.5	6.5	mA
Dynamic	characteristics					
C _d	diode capacitance	f = 1 MHz; V _R = 10 V; T _j = 25 °C; see <u>Figure 8</u>	-	250	-	pF





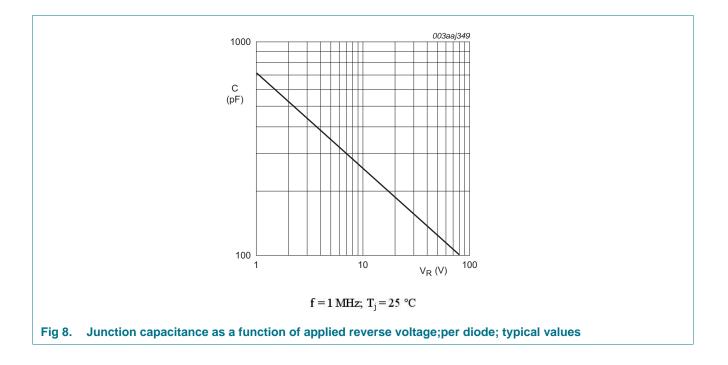


NXPS20H110C

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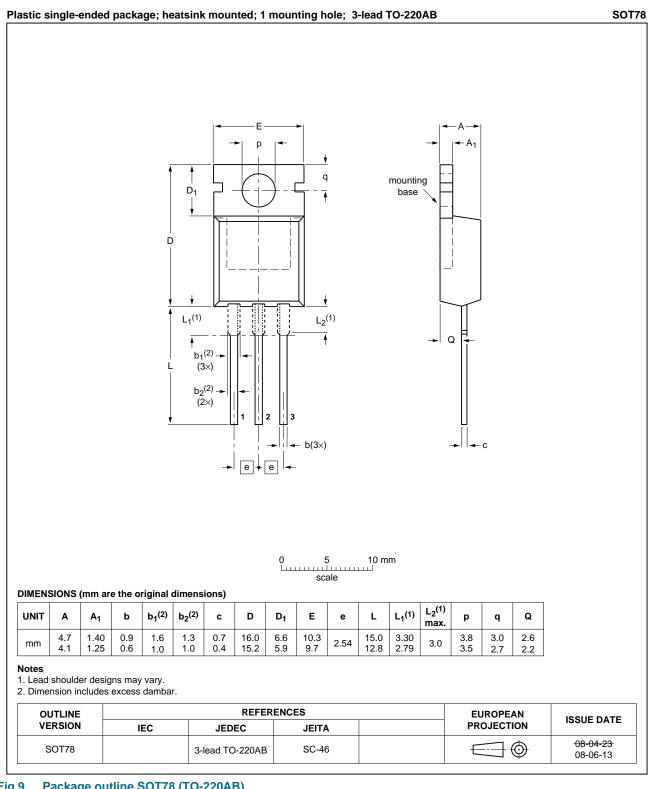
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Package outline 7.



Package outline SOT78 (TO-220AB) Fig 9.

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Dual power Schottky diode

8. Revision history

Table 7.Revision	history			
Document ID	Release date	Data sheet status	Change notice	Supersedes
NXPS20H110C v.2	20120524	Product data sheet	-	NXPS20H110C v.1
Modifications:	 Status change 	d from preliminary to produc	t.	
	 Various chang 	es to content.		
NXPS20H110C v.1	20120420	Preliminary data shee	t -	-

9. Legal information

9.1 Data sheet status

Document status[1] [2]	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions"

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